

High speed 1200 V TRENCHSTOP™ IGBT 7 Technology co-packed with full rated current, soft-commutating, ultra-fast recovery and low Qrr emitter controlled 7 Rapid diode

Features

- $V_{CE} = 1200 \text{ V}$
- $I_C = 75 \text{ A}$
- Maximum junction temperature $T_{vjmax} = 175^\circ\text{C}$
- Best-in-class high speed IGBT co-packed with full rated current, low Q_{rr} and soft-commutating high speed diode
- Low saturation voltage $V_{CESat} = 1.7 \text{ V}$ at $T_{vj} = 25^\circ\text{C}$
- Optimized for high efficiency in high speed hard switching topologies (2-L inverter, 3-L NPC T-type, ...)
- Easy paralleling capability due to positive temperature coefficient in V_{CESat}
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

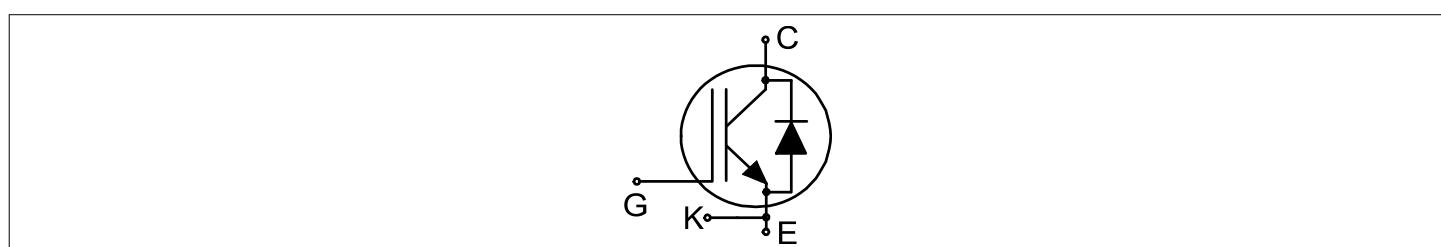
Potential applications

- Industrial UPS
- EV-Charging
- String inverter
- Welding

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description



Halogen-free



Lead-free



Green



RoHS

Type	Package	Marking
IKZA75N120CH7	PG-T0247-4-STD-NT3.7	K75MCH7

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1 Package

1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting process: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$			0.21	0.27	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.36	0.47	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit		
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25^\circ\text{C}$	1200			V		
DC collector current, limited by T_{vjmax}	I_C	limited by bondwire	$T_c = 25^\circ\text{C}$	109		A		
			$T_c = 100^\circ\text{C}$	94				
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}		300			A		
Turn-off safe operating area		$V_{CC} \leq 800\text{ V}$, $V_{CE,\text{peak}} < 1200\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{Goff} \geq 18\text{ }\Omega$, $T_{vj} \leq 175^\circ\text{C}$	300			A		
Gate-emitter voltage	V_{GE}		±20			V		
Transient gate-emitter voltage	V_{GE}	$t_p \leq 0.5\text{ }\mu\text{s}$, $D < 0.001$	±25			V		
Power dissipation	P_{tot}		$T_c = 25^\circ\text{C}$	549		W		
			$T_c = 100^\circ\text{C}$	275				

Table 3 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CESat}	$I_C = 75\text{ A}$, $V_{GE} = 15\text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.7	V
			$T_{vj} = 175^\circ\text{C}$		2	

(table continues...)

Datasheet

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Gate-emitter threshold voltage	$V_{GE\text{th}}$	$I_C = 1.2 \text{ mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25^\circ\text{C}$	4.7	5.5	6.2	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 1200 \text{ V}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		40	μA
			$T_{vj} = 175^\circ\text{C}$		4600	
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = 20 \text{ V}$			100	nA
Transconductance	g_{fs}	$I_C = 75 \text{ A}$, $V_{CE} = 20 \text{ V}$		193		S
Input capacitance	C_{ies}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		9.6		nF
Output capacitance	C_{oes}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		184		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		54		pF
Gate charge	Q_G	$I_C = 75 \text{ A}$, $V_{GE} = 15 \text{ V}$, $V_{CC} = 960 \text{ V}$		550		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25^\circ\text{C}$, $I_C = 75 \text{ A}$		40	ns
			$T_{vj} = 175^\circ\text{C}$, $I_C = 75 \text{ A}$		37	
Rise time (inductive load)	t_r	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25^\circ\text{C}$, $I_C = 75 \text{ A}$		15	ns
			$T_{vj} = 175^\circ\text{C}$, $I_C = 75 \text{ A}$		18	
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25^\circ\text{C}$, $I_C = 75 \text{ A}$		359	ns
			$T_{vj} = 175^\circ\text{C}$, $I_C = 75 \text{ A}$		435	
Fall time (inductive load)	t_f	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25^\circ\text{C}$, $I_C = 75 \text{ A}$		38	ns
			$T_{vj} = 175^\circ\text{C}$, $I_C = 75 \text{ A}$		122	
Turn-on energy	E_{on}	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25^\circ\text{C}$, $I_C = 75 \text{ A}$		2.01	mJ
			$T_{vj} = 175^\circ\text{C}$, $I_C = 75 \text{ A}$		3.16	
Turn-off energy	E_{off}	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25^\circ\text{C}$, $I_C = 75 \text{ A}$		1.76	mJ
			$T_{vj} = 175^\circ\text{C}$, $I_C = 75 \text{ A}$		4.04	

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Total switching energy	E_{ts}	$V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 5.3 \Omega$, $R_{G(off)} = 5.3 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_c = 75 \text{ A}$		3.77	mJ
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_c = 75 \text{ A}$		7.2	
Operating junction temperature	T_{vj}		-40		175	${}^\circ\text{C}$

Note: Electrical Characteristic, at $T_{vj} = 25 \text{ }^\circ\text{C}$, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward current, limited by T_{vjmax}	I_F	limited by bondwire	$T_c = 25 \text{ }^\circ\text{C}$	96		A
			$T_c = 97 \text{ }^\circ\text{C}$	75		
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}			300		A
Power dissipation	P_{tot}		$T_c = 25 \text{ }^\circ\text{C}$	321		W
			$T_c = 100 \text{ }^\circ\text{C}$	160		

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 75 \text{ A}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		2.5	V
			$T_{vj} = 175 \text{ }^\circ\text{C}$		2.3	
Diode reverse recovery time	t_{rr}	$V_R = 600 \text{ V}$, $R_{G(on)} = 5.3 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		95	ns
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		180	
Diode reverse recovery charge	Q_{rr}	$V_R = 600 \text{ V}$, $R_{G(on)} = 5.3 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		2.44	μC
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		7.43	
Diode peak reverse recovery current	I_{rrm}	$V_R = 600 \text{ V}$, $R_{G(on)} = 5.3 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		82	A
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		135	

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 600 \text{ V}$, $R_{G(on)} = 5.3 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		-2370	$\text{A}/\mu\text{s}$
			$T_{vj} = 150 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		-3300	
Reverse recovery energy	E_{rec}	$V_R = 600 \text{ V}$, $R_{G(on)} = 5.3 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		0.82	mJ
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 75 \text{ A}$		2.93	
Operating junction temperature	T_{vj}			-40	175	${}^\circ\text{C}$

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Dynamic test circuit, parasitic inductance $L_\sigma = 30 \text{ nH}$, $C_\sigma = 18 \text{ pF}$

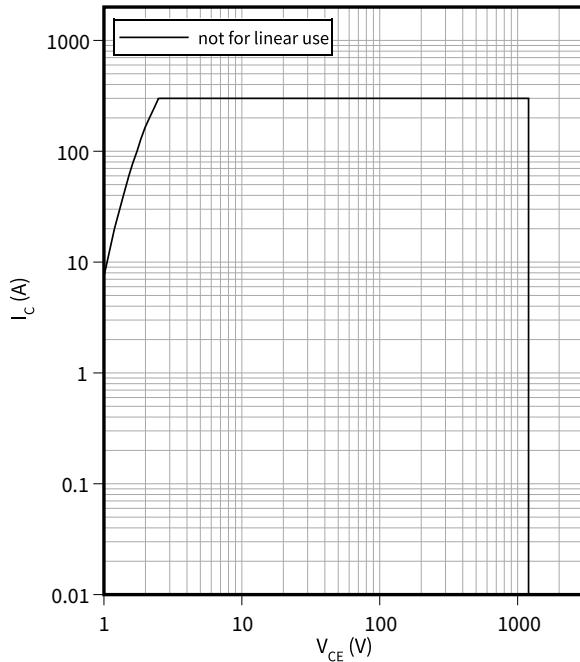
4 Characteristics diagrams

4 Characteristics diagrams

Reverse bias safe operating area

$$I_C = f(V_{CE})$$

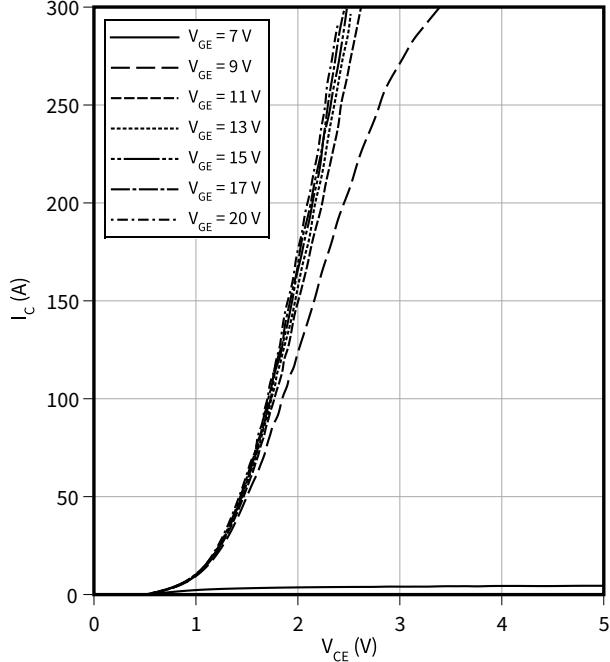
$$T_{vj} \leq 175^\circ C, V_{GE} = 0/15 V$$



Typical output characteristic

$$I_C = f(V_{CE})$$

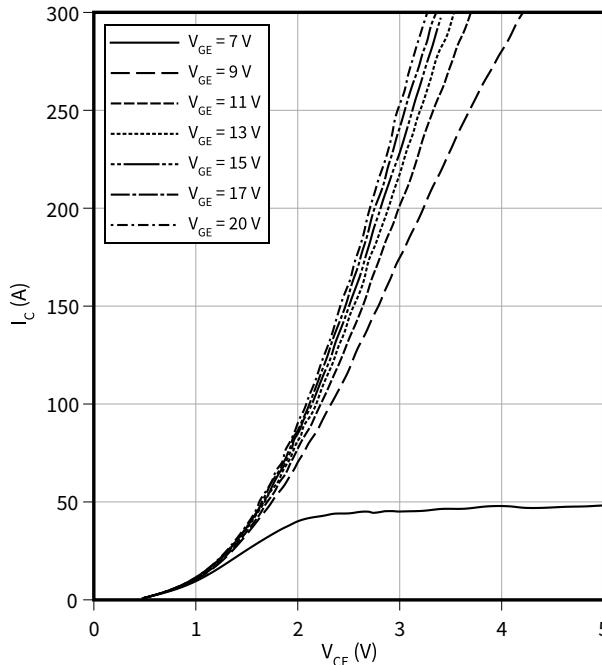
$$T_{vj} = 25^\circ C$$



Typical output characteristic

$$I_C = f(V_{CE})$$

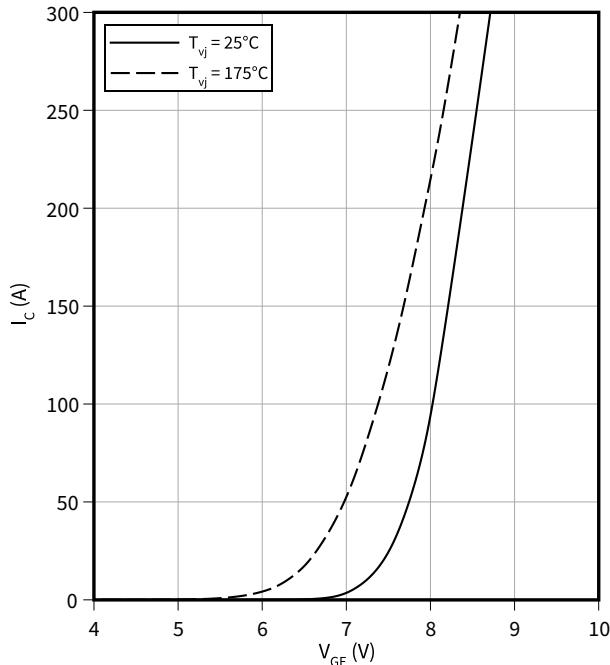
$$T_{vj} = 175^\circ C$$



Typical transfer characteristic

$$I_C = f(V_{GE})$$

$$V_{CE} = 20 V$$

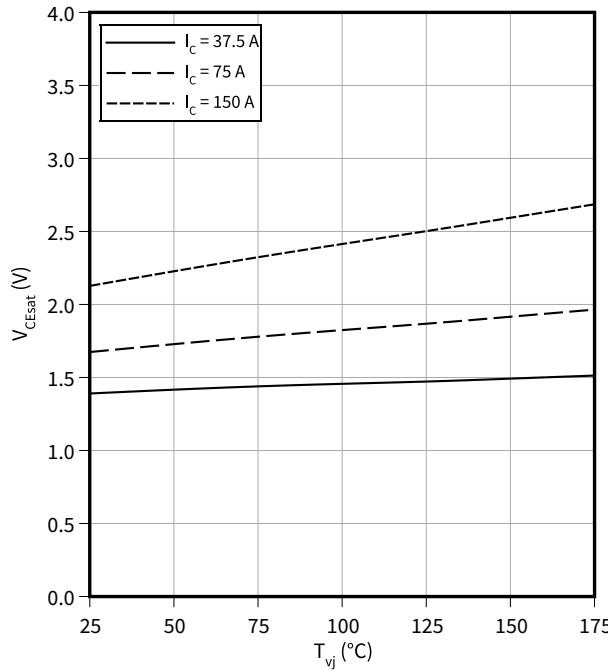


4 Characteristics diagrams

Typical collector-emitter saturation voltage as a function of junction temperature

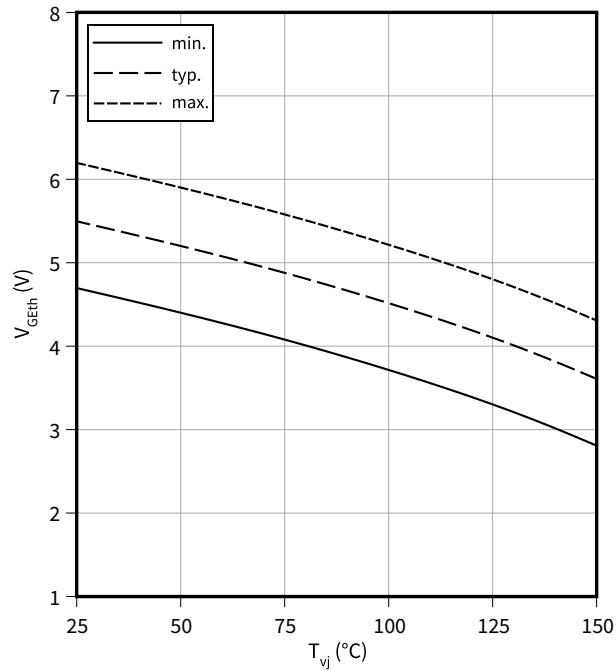
$$V_{CEsat} = f(T_{vj})$$

$$V_{GE} = 15 \text{ V}$$

**Gate-emitter threshold voltage as a function of junction temperature**

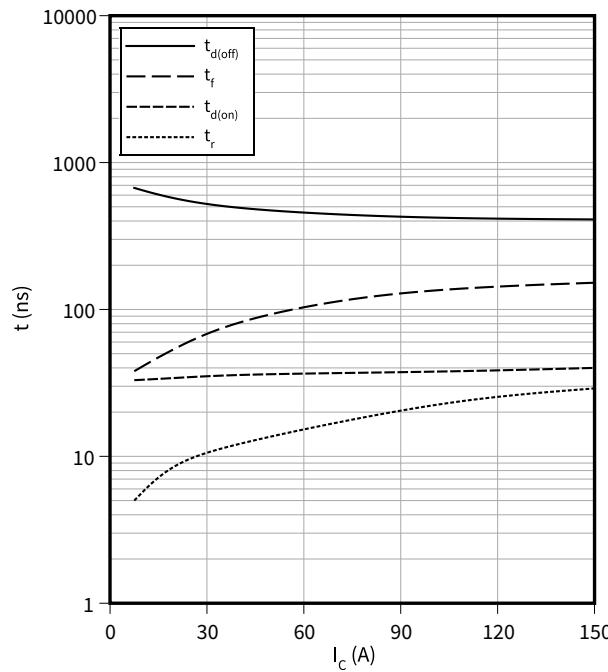
$$V_{GETh} = f(T_{vj})$$

$$I_C = 1.2 \text{ mA}$$

**Typical switching times as a function of collector current**

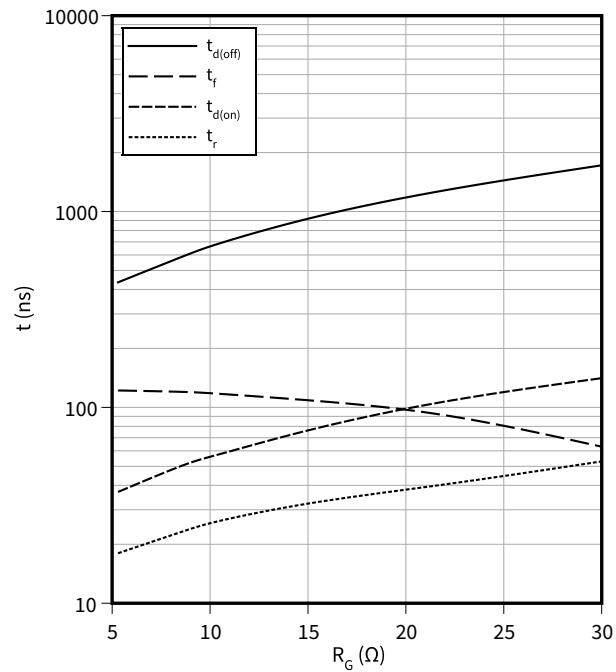
$$t = f(I_C)$$

$$V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 5.3 \Omega$$

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$

$$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$$

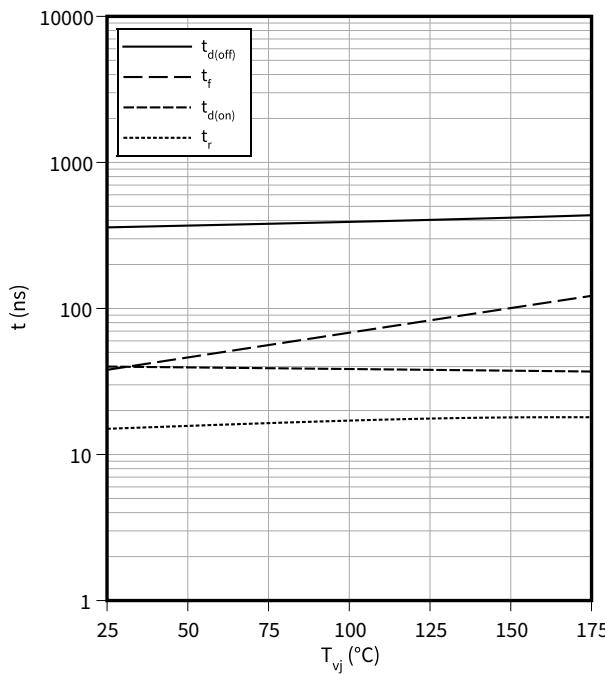


4 Characteristics diagrams

Typical switching times as a function of junction temperature

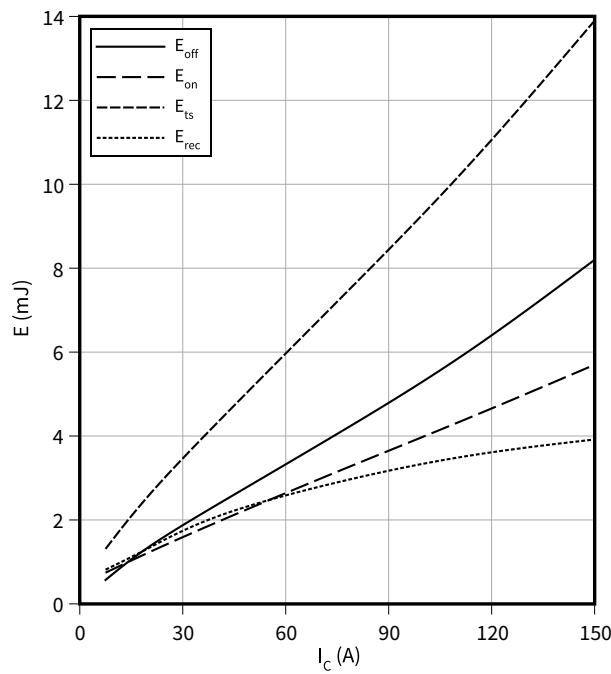
$$t = f(T_{vj})$$

$I_C = 75 \text{ A}$, $V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 5.3 \Omega$

**Typical switching energy losses as a function of collector current**

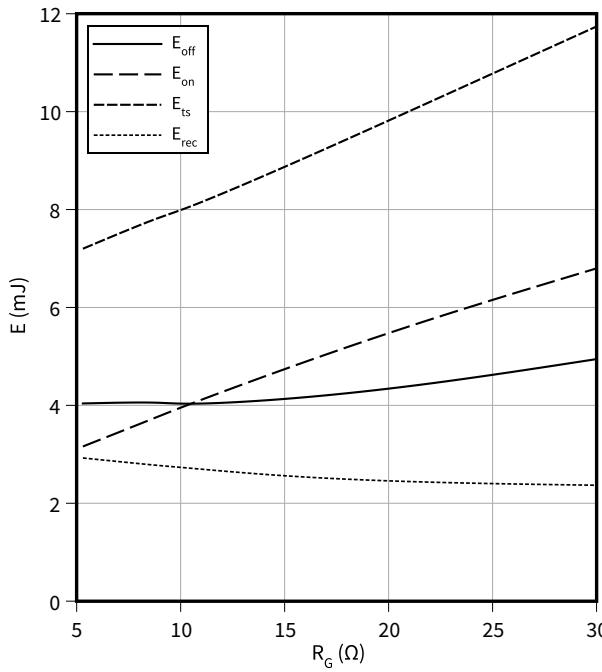
$$E = f(I_C)$$

$V_{CC} = 600 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 5.3 \Omega$

**Typical switching energy losses as a function of gate resistor**

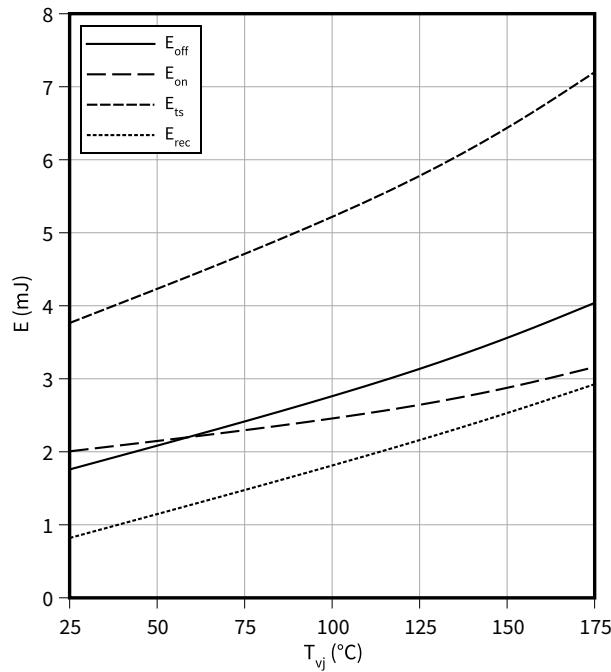
$$E = f(R_G)$$

$I_C = 75 \text{ A}$, $V_{CC} = 600 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$

**Typical switching energy losses as a function of junction temperature**

$$E = f(T_{vj})$$

$I_C = 75 \text{ A}$, $V_{CC} = 600 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 5.3 \Omega$

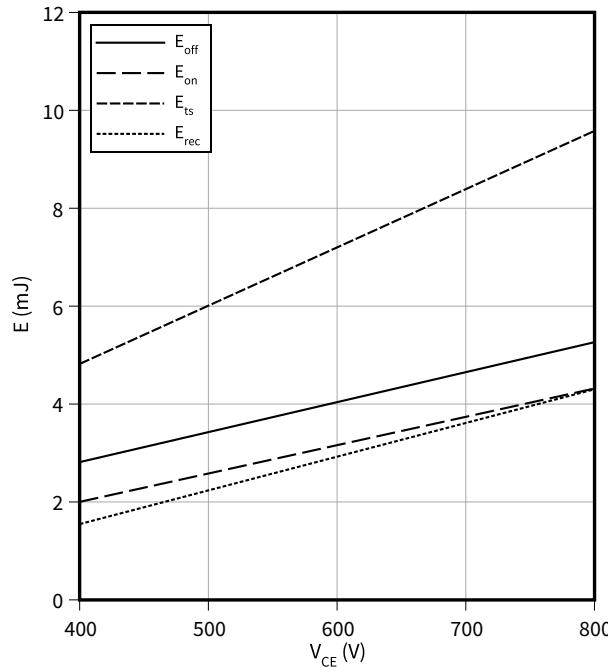


4 Characteristics diagrams

Typical switching energy losses as a function of collector-emitter voltage

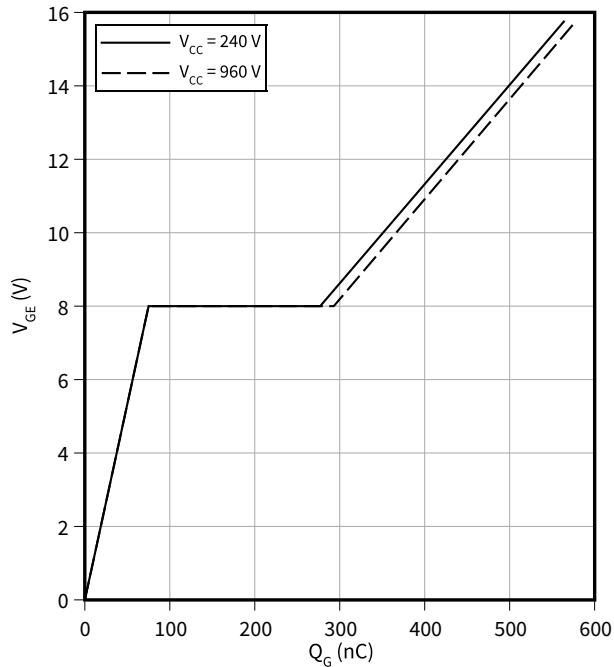
$$E = f(V_{CE})$$

$$I_C = 75 \text{ A}, T_{vj} = 175^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 5.3 \Omega$$

**Typical gate charge**

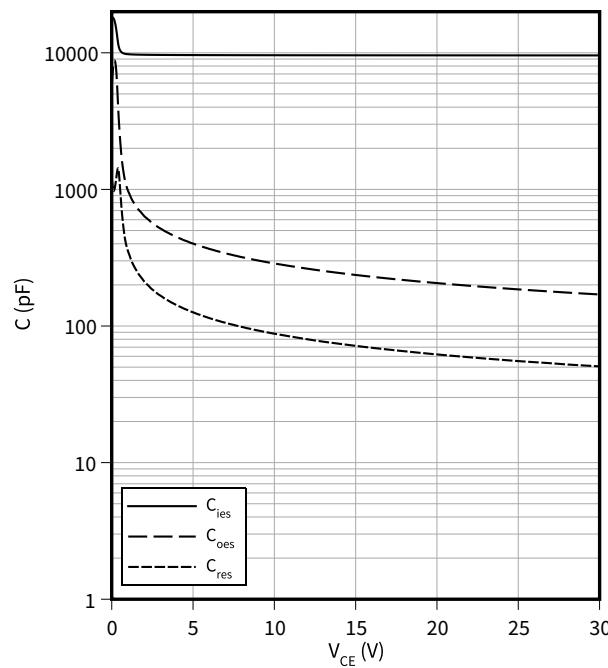
$$V_{GE} = f(Q_G)$$

$$I_C = 75 \text{ A}$$

**Typical capacitance as a function of collector-emitter voltage**

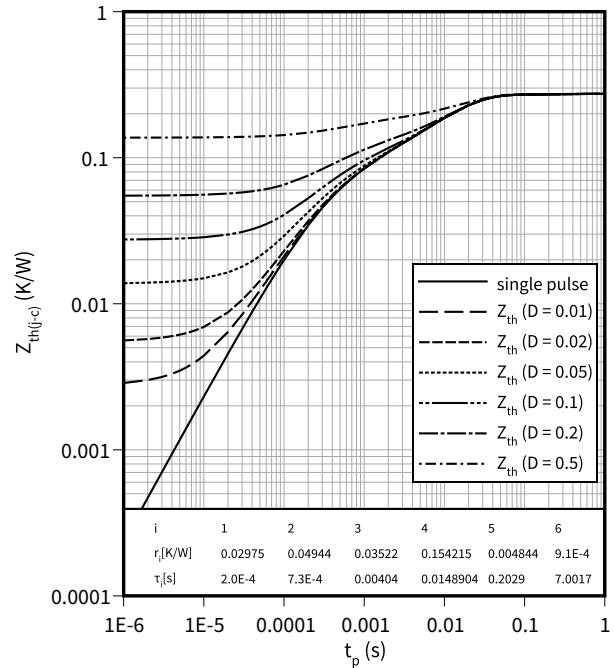
$$C = f(V_{CE})$$

$$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$$

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$

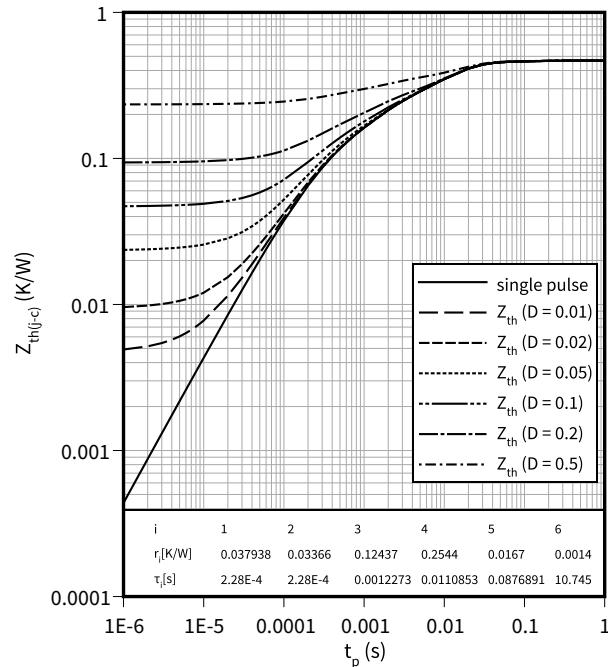


4 Characteristics diagrams

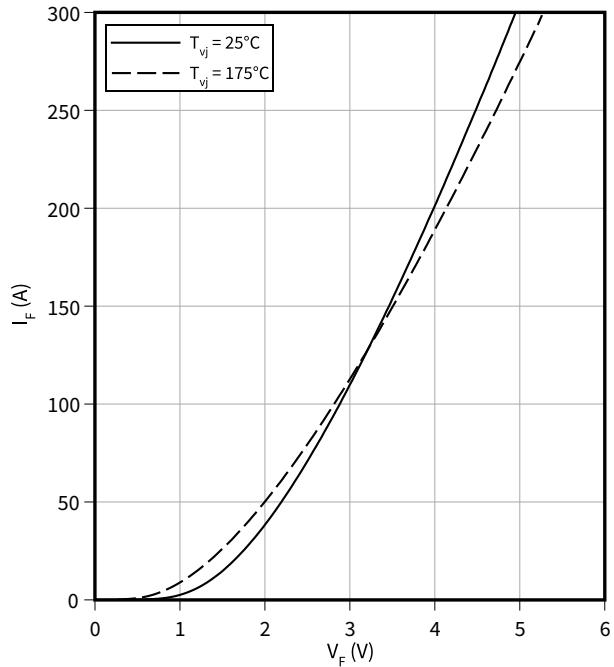
Diode transient thermal impedance as a function of pulse width

$$Z_{th(j-c)} = f(t_p)$$

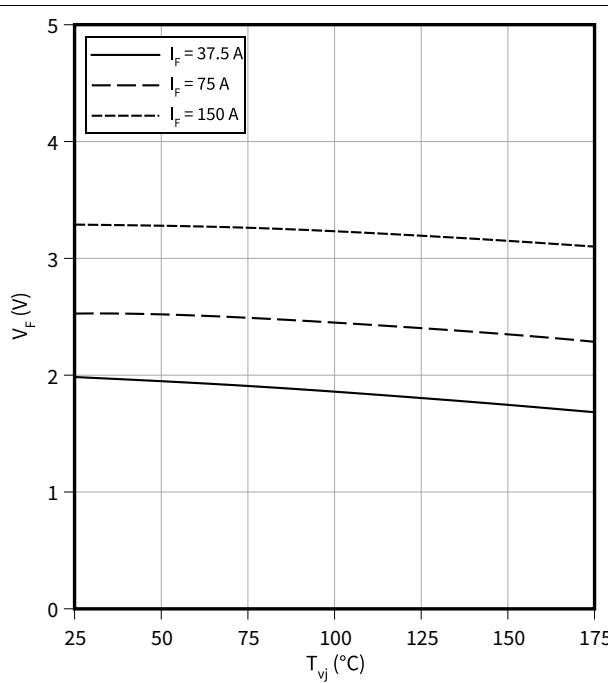
$$D = t_p/T$$

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

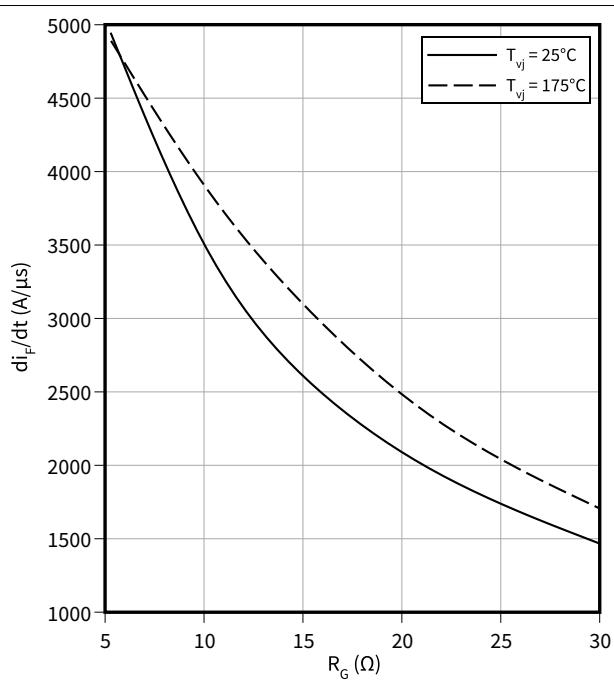
**Typical diode forward voltage as a function of junction temperature**

$$V_F = f(T_{vj})$$

**Typical diode current slope as a function of gate resistor**

$$di_F/dt = f(R_G)$$

$$V_R = 600 \text{ V}, I_F = 75 \text{ A}$$

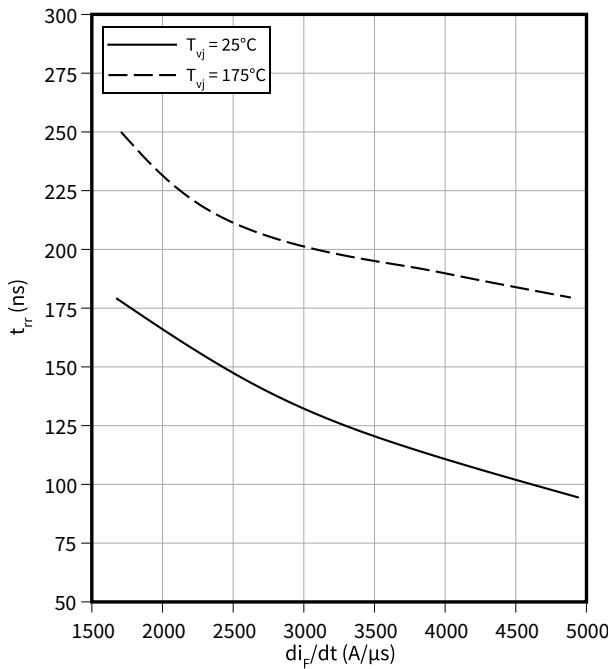


4 Characteristics diagrams

Typical reverse recovery time as a function of diode current slope

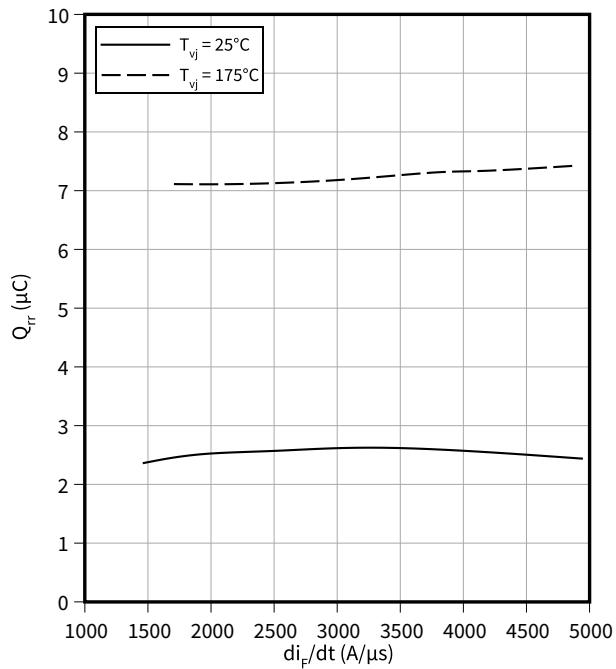
$$t_{rr} = f(di_F/dt)$$

$V_R = 600 \text{ V}$, $I_F = 75 \text{ A}$

**Typical reverse recovery charge as a function of diode current slope**

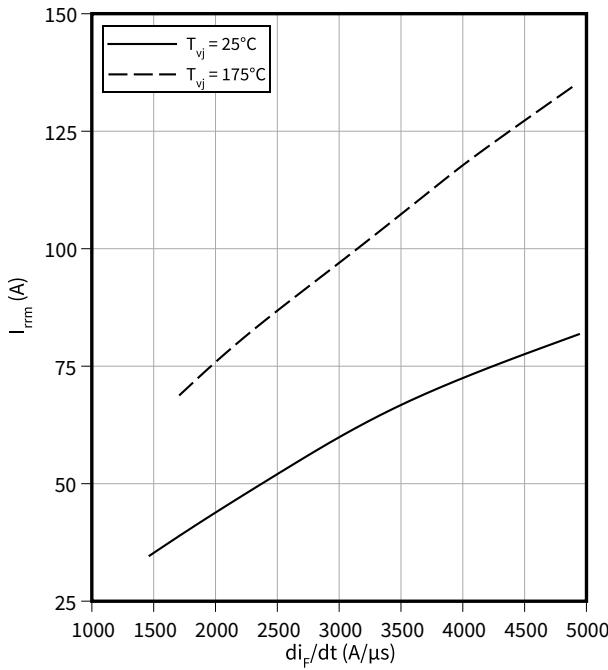
$$Q_{rr} = f(di_F/dt)$$

$V_R = 600 \text{ V}$, $I_F = 75 \text{ A}$

**Typical reverse recovery current as a function of diode current slope**

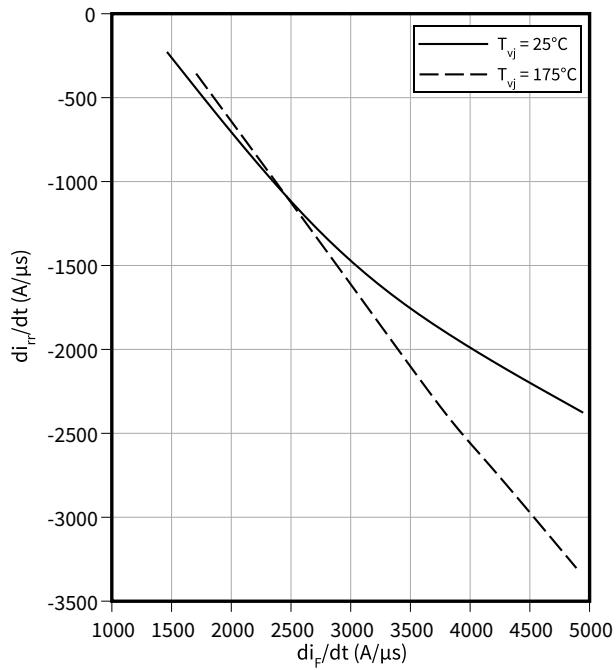
$$I_{rrm} = f(di_F/dt)$$

$V_R = 600 \text{ V}$, $I_F = 75 \text{ A}$

**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

$$di_{rr}/dt = f(di_F/dt)$$

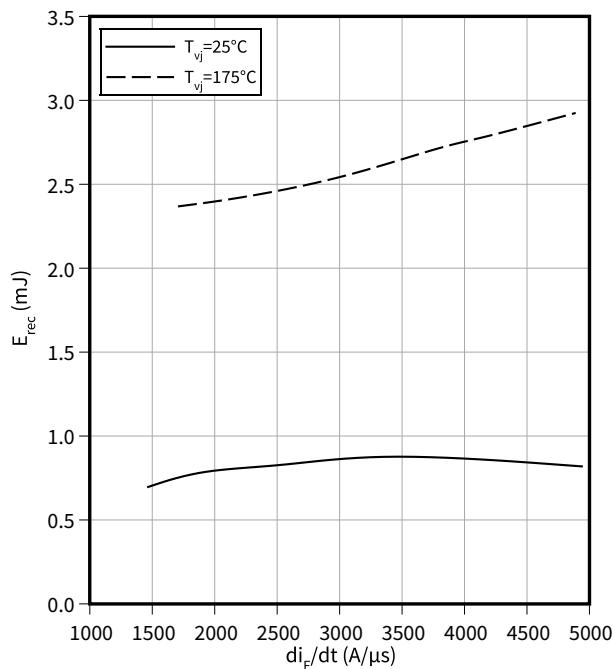
$V_R = 600 \text{ V}$, $I_F = 75 \text{ A}$



4 Characteristics diagrams

Typical reverse energy losses as a function of diode current slope

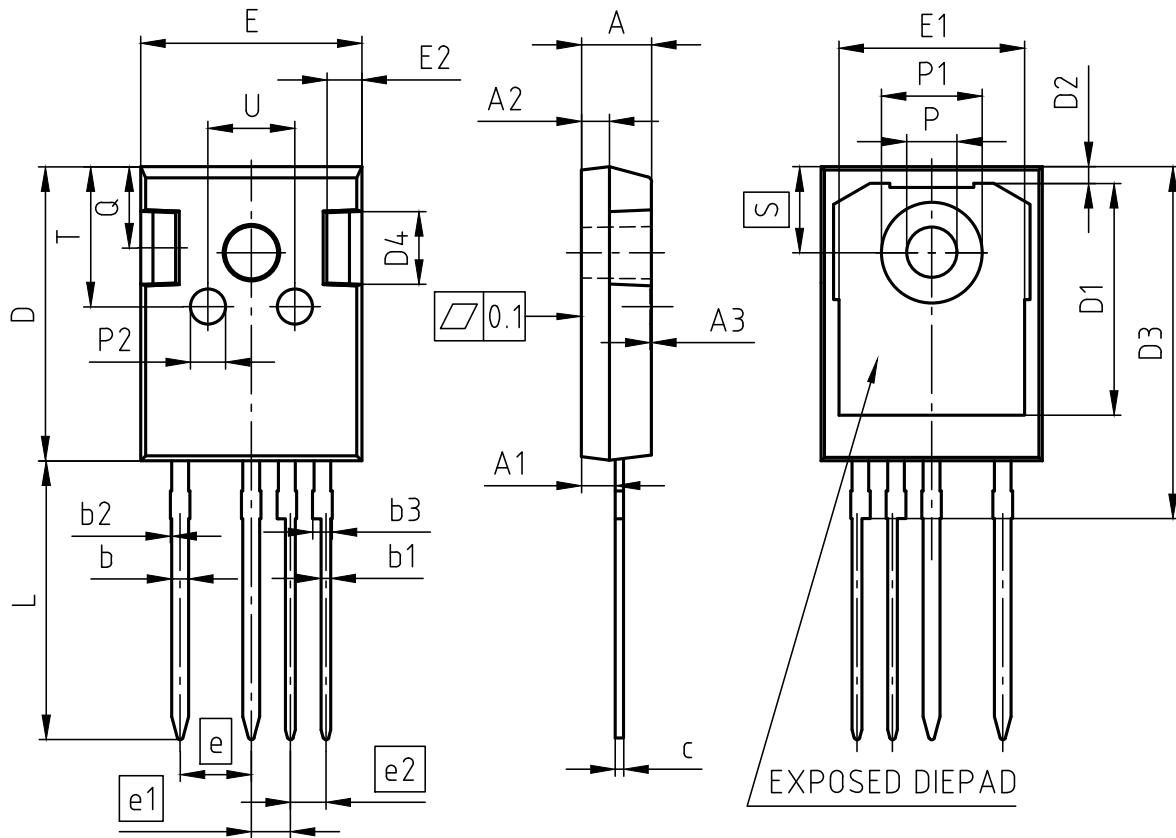
$$E_{rec} = f(di_F/dt)$$

 $V_R = 600 \text{ V}, I_F = 75 \text{ A}$ 

5 Package outlines

5 Package outlines

PG-T0247-4-STD-NT3.7



NOTES:

ALL DIMENSIONS DO NOT INCLUDE MOLD FLASH
OR PROTRUSIONS.

PACKAGE - GROUP NUMBER: PG-T0247-4-U02					
DIMENSIONS	MILLIMETERS		DIMENSIONS	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	4.90	5.10	E	15.70	15.90
A1	2.31	2.51	E1	13.10	13.50
A2	1.90	2.10	E2	2.40	2.60
A3	0.05	0.25	e	5.08	
b	1.10	1.30	e1	2.79	
b1	0.65	0.79	e2	2.54	
b2	---	0.20	N	4	
b3	1.34	1.44	L	19.80	20.10
c	0.58	0.66	øP	3.50	3.70
D	20.90	21.10	øP1	7.00	7.40
D1	16.25	16.85	øP2	2.40	2.60
D2	1.05	1.35	Q	5.60	6.00
D3	24.97	25.27	S	6.15	
D4	4.90	5.10	T	9.80	10.20
			U	6.00	6.40

Figure 1

6 Testing conditions

6 Testing conditions

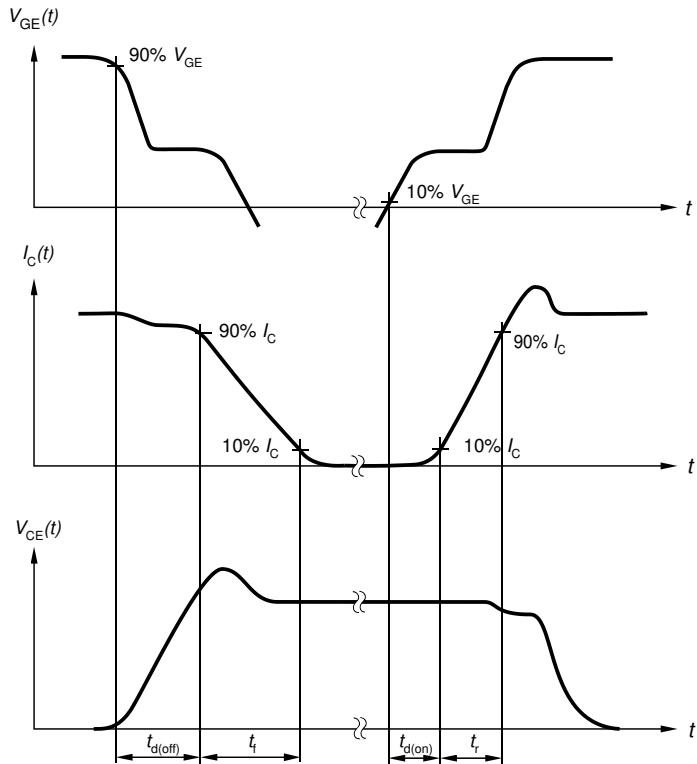


Figure A. Definition of switching times

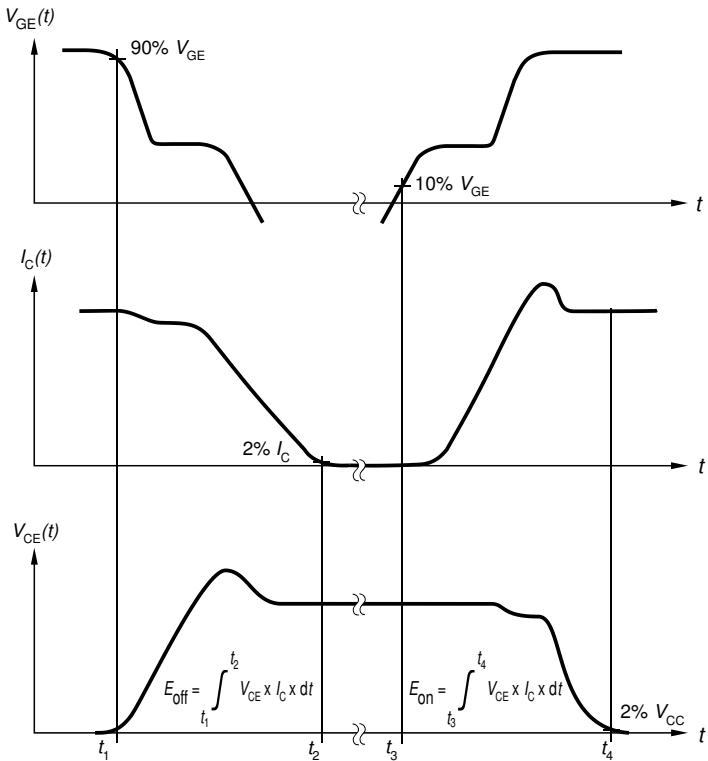


Figure B. Definition of switching losses

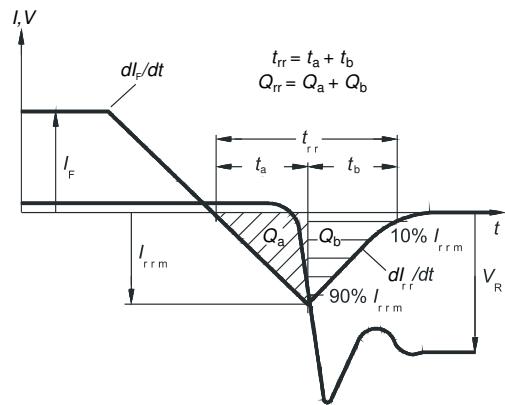


Figure C. Definition of diode switching characteristics

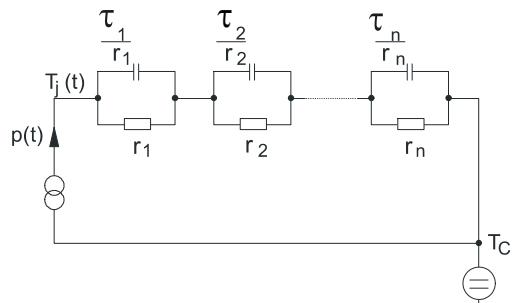


Figure D. Thermal equivalent circuit

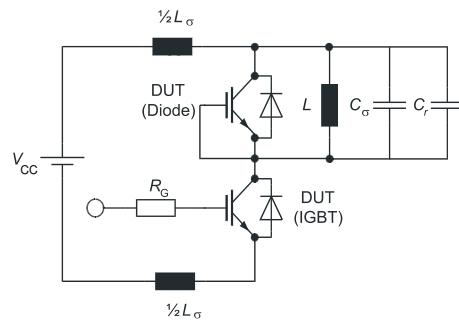


Figure E. Dynamic test circuit
 Parasitic inductance L_σ ,
 parasitic capacitor C_σ ,
 relief capacitor C_r ,
 (only for ZVT switching)

Figure 2

Revision history

Document revision	Date of release	Description of changes
0.10	2022-05-02	Target datasheet
0.20	2022-06-01	Editorial changes
1.00	2022-10-31	Final datasheet
1.10	2022-11-23	Update of potential applications